AMENDMENTS

Please enter the following amendments:

In the Claims

Please amend the claims as indicated below. The language being added is underlined ("___") and the language being deleted contains strikethrough ("___"):

- (Original) A substrate adapted for use in integrated circuits, the substrate comprising:

 a first substrate layer comprising an organic material;
 a first conductor layer fabricated on an upper surface of the first substrate layer; and
 an integrated inductor fabricated on an upper surface of the first conductor layer.
- 2. (Original) The substrate of claim 1, wherein the integrated inductor comprises a spiral inductor.
- 3. (Original) The substrate of claim 1, wherein the integrated inductor comprises a microstrip loop inductor.
- 4. (Original) The substrate of claim 1, wherein the organic material is at least one of an epoxy-based material and a liquid crystalline polymer.
- 5. (Original) The substrate of claim 1, further comprising a second conductor layer fabricated on a lower surface of the first substrate layer, the second conductor layer adapted as a ground plane for the first conductor layer.

- 6. (Original) The substrate of claim 1, wherein the integrated inductor and the first conductor layer are configured in a coplanar waveguide arrangement.
- 7. (Original) The substrate of claim 1, wherein the integrated inductor comprises a cascaded loop inductor comprising one or more microstrip loop inductors cascaded together.
- 8. (Original) The substrate of claim 1, further comprising a second conductor layer fabricated on a lower surface of the first substrate layer, wherein two points of the integrated inductor are electrically connected through a via connected to the second conductor layer.
- (Original) The substrate of claim 8, further comprising:
 a second substrate layer fabricated on a lower surface of the second conductor layer; and
 a third conductor layer fabricated on a lower surface of the second substrate layer.
- 10. (Original) The substrate of claim 9, wherein the second substrate layer comprises an organic material.
- 11. (Original) The substrate of claim 10, wherein the organic material is at least one of an epoxy-based material and a liquid crystalline polymer.
- 12.-22. (Cancelled)

a first substrate layer;
a first conductor layer fabricated on an upper surface of the first substrate layer; and
an integrated inductor fabricated on an upper surface of the first conductor layer, the
integrated inductor comprising a microstrip spiral inductor having a strip width between
approximately 4 mils and 40 mils and a line spacing between approximately 2 mils and 4 mils.

(Original) A substrate adapted for use in integrated circuits, the substrate comprising:

23.

- 24. (Original) The substrate of claim 23, wherein the first substrate layer comprises an organic material.
- 25. (Original) The substrate of claim 24, wherein the organic material is at least one of an epoxy-based material and a liquid crystalline polymer.
- 26. (Original) The substrate of claim 23, wherein the line width, line spacing, and number of turns for the microstrip spiral inductor are configured to optimize at least one of a frequency for a maximum Q factor, an effective inductance, and a self resonant frequency.
- 27. (Original) The substrate of claim 23, wherein the microstrip spiral inductor comprises a three-turn microstrip.
- 28. (Original) The substrate of claim 27, wherein the microstrip spiral inductor has a line width of approximately 10 mils, a line spacing of approximately 2 mils, and an area of approximately 4.4 millimeters².

- 29. (Original) The substrate of claim 28, wherein the microstrip spiral inductor has an effective inductance of approximately 12 nH at approximately 1.5 GHz, a maximum Q factor of approximately 80 at approximately 1.5 GHz, and a self resonating frequency of approximately 3.9 GHz.
- 30. (Original) The substrate of claim 27, wherein the microstrip spiral inductor has a line width of approximately 7 mils, a line spacing of approximately 2 mils, and an area of approximately 3.1 millimeters².
- 31. (Original) The substrate of claim 30, wherein the microstrip spiral inductor has an effective inductance of approximately 12 nH at approximately 1 GHz, a maximum Q factor of approximately 100 at approximately 1 GHz, and a self resonating frequency of approximately 3.2 GHz.
- 32. (Original) The substrate of claim 23, wherein the microstrip spiral inductor comprises a two-turn microstrip.
- 33. (Original) The substrate of claim 32, wherein the microstrip spiral inductor has a line width of approximately 10 mils, a line spacing of approximately 4 mils, and an area of approximately 3.2 millimeters².

- 34. (Original) The substrate of claim 33, wherein the microstrip spiral inductor has an effective inductance of approximately 7 nH at approximately 2 GHz, a maximum Q factor of approximately 100 at approximately 2 GHz, and a self resonating frequency of approximately 6.8 GHz.
- 35. (Original) The substrate of claim 32, wherein the microstrip spiral inductor has a line width of approximately 18 mils, a line spacing of approximately 4 mils, and an area of approximately 4.5 millimeters².
- 36. (Original) The substrate of claim 35, wherein the microstrip spiral inductor has an effective inductance of approximately 5.2 nH at approximately 2 GHz, a maximum Q factor of approximately 110 at approximately 2 GHz, and a self resonating frequency of approximately 7 GHz.
- 37. (Original) The substrate of claim 23, wherein the microstrip spiral inductor comprises a one-turn microstrip.
- 38. (Original) The substrate of claim 37, wherein the microstrip spiral inductor has a line width of approximately 34 mils, a line spacing of approximately 4 mils, and an area of approximately 3.2 millimeters².

- 39. (Original) The substrate of claim 38, wherein the microstrip spiral inductor has an effective inductance of approximately 1.5 nH at approximately 2.4 GHz, a maximum Q factor of approximately 170 at approximately 2.4 GHz, and a self resonating frequency of approximately 8.5 GHz.
- 40. (Original) A substrate adapted for use in integrated circuits, the substrate comprising: a first substrate layer; a first conductor layer fabricated on an upper surface of the first substrate layer; and an integrated inductor fabricated on an upper surface of the first conductor layer, the integrated inductor comprising a coplanar waveguide loop inductor.
- 41. (Original) The substrate of claim 40, wherein the first substrate layer comprises an organic material.
- 42. (Original) The substrate of claim 41, wherein the organic material is at least one of an epoxy-based material and a liquid crystalline polymer.
- 43. (Original) The substrate of claim 40, wherein the number of loops comprising the coplanar waveguide loop inductor is configured to optimize at least one of a frequency for a maximum Q factor, an effective inductance, and a self resonant frequency.
- 44. (Original) The substrate of claim 40, wherein the coplanar waveguide loop inductor comprises hollow-ground coplanar waveguide loop inductor.

- 45. (Original) A substrate adapted for use in integrated circuits, the substrate comprising:

 a first substrate layer;

 a first conductor layer fabricated on an upper surface of the first substrate layer; and
 an integrated inductor fabricated on an upper surface of the first conductor layer, the
- integrated inductor comprising a microstrip loop inductor.
- 46. (Original) The substrate of claim 45, wherein the configuration of the microstrip loop inductor is designed to optimize at least one of a frequency for a maximum Q factor, an effective inductance, and a self resonant frequency.
- 47. (Original) The substrate of claim 45, wherein the number of loops and the line width of the microstrip loop inductor are designed to optimize at least one of a frequency for a maximum Q factor, an effective inductance, and a self resonant frequency.
- 48. (Original) The substrate of claim 45, wherein the microstrip loop inductor comprises a single loop having a line width of approximately 2 mils and an area of approximately 3.5 millimeters².
- 49. (Original) The substrate of claim 48, wherein the microstrip loop inductor has an effective inductance of approximately 7.7 nH, a maximum Q factor of approximately 90 at approximately 2.4 GHz, and a self resonating frequency of approximately 7.2 GHz.

- 50. (Original) The substrate of claim 45, wherein the microstrip loop inductor comprises two cascaded loops.
- 51. (Original) The substrate of claim 50, wherein the microstrip loop inductor has a line width of approximately 6 mils and an area of approximately 4.3 millimeters².
- 52. (Original) The substrate of claim 51, wherein the microstrip loop inductor has an effective inductance of approximately 7.8 nH, a maximum Q factor of approximately 110 at approximately 2.1 GHz, and a self resonating frequency of approximately 6 GHz.
- 53. (Original) The substrate of claim 52, wherein the microstrip loop inductor has a line width of approximately 4 mils and an area of approximately 3.5 millimeters².
- 64. (Original) The substrate of claim 50, wherein the microstrip loop inductor has an effective inductance of approximately 10.2 nH, a maximum Q factor of approximately 85 at approximately 2.2 GHz, and a self resonating frequency of approximately 5 GHz.
- 55. (Original) The substrate of claim 45, wherein the microstip loop inductor comprises three cascaded loops.

- 56. (Original) The substrate of claim 55, wherein the microstrip loop inductor has an area of approximately 4 millimeters² and a first portion of the microstrip loop inductor has a line width of approximately 4 mils and a second portion of the microstrip loop inductor has a line width of approximately 8 mils.
- 57. (Original) The substrate of claim 56, wherein the microstrip loop inductor has an effective inductance of approximately 15 nH, a maximum Q factor of approximately 80 at approximately 1 GHz, and a self resonating frequency of approximately 3.2 GHz.
- 58. (Original) The substrate of claim 55, wherein the microstrip loop inductor has an area of approximately 4 millimeters² and a first portion of the microstrip loop inductor has a line width of approximately 4 mils and a second portion of the microstrip loop inductor has a line width of approximately 2 mils.
- 59. (Original) The substrate of claim 58, wherein the microstrip loop inductor has an effective inductance of approximately 17 nH, a maximum Q factor of approximately 70 at approximately 1 GHz, and a self resonating frequency of approximately 3 GHz.
- 60.-125. (Cancelled)